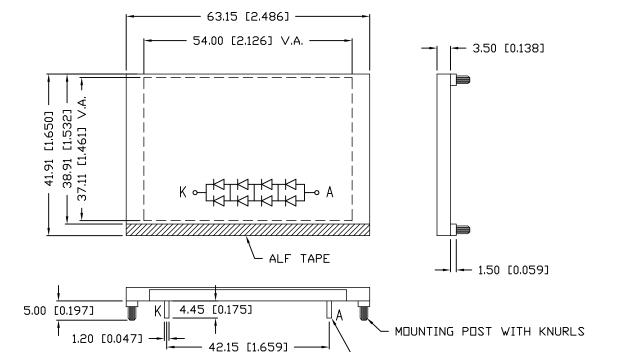
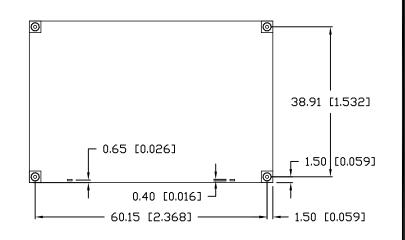
## PART NUMBER SSB—CEL5435SUGW

REV. E.C.N. NUMBER AND REVISION COMMENTS DATE

A E.C.N. #11604. 12.15.09

REV.





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ELECTRO-OPTICAL CHA	ARACTERIST	TCS TA=25	5°C PER M	ODULE	If= 40 mA 🔺
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		574		nm	
FORWARD VOLTAGE		8.8	10	$V_{f}$	
REVERSE VOLTAGE	5.0			$V_{r}$	Vr =100µA
LUMINOUS INTENSITY		60		cd/m <sup>2</sup>	If = 40 mA A
EMITTED COLOR:	GREEN				
REFLECTOR FINISH:	WHITE (	DIFFUSED			

LIMITS OF SAIL OF LIVATION AT 25 C	FEN LLD	
PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA mA
STEADY CURRENT	50	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING TEMP.	-20  TO  +70	<b>.</b> C
STORAGE TEMP.	-40 TO +80	<b>.</b> C
SOLDERING TEMP.	+ 260	<b>.</b> C
2.0mm FROM BODY		3 SEC. MAX
* +<10C		

\* t<10µS

\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= +DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= +DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= +DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.010), X.XX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN= +DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.010), X.XX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.000), LEAD LENGTH=±0.75 (±0.030). MIN= +DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.010), X.XX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.000), X.X=±0.05 (±0.000), X

A SSB-CEL5435SUGW

54mm x 35mm LED BACKLIGHT, 574nm AlinGaP GREEN LEDS, WHITE DIFFUSED. CONFIDENTIAL INFORMATION
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PLATED PCB PINS

RELIABILITY NOTE

OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT

SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE.

PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



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PAGE: 1 OF 1
SCALE: N/A